



# Product Change Notification

**Change Notification #:** 115174 - 00  
**Change Title:** Intel® Dual Band Wireless-AC 3165  
SKUs: 3165.NGWG.S; 3165.NGWG,  
PCN 115174-00, Transport Media,  
Packaging Update  
**Date of Publication:** December 13, 2016

## Key Characteristics of the Change:

Transport Media

## Forecasted Key Milestones:

<b>Date Customer Must be Ready to Receive Post-Conversion Material:</b>	Dec 26, 2016
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## Description of Change to the Customer:

The Intel® Dual Band Wireless-AC 3165 SKUs listed in the products affected table below will undergo the following changes:

- Adding the Korea recycle logo to clamshell packaging



## Customer Impact of Change and Recommended Action:

The recycling logo change does not affect the functionality of the product. Customers should be aware of the changes and take any necessary steps to insure no impact for their receiving and processing of the product in their manufacturing.

Intel will attempt to deplete pre-conversion material before shipping post-conversion material but there is a possibility of Intel shipping mixed inventory. Therefore, customers will need to manage and migrate to the post-conversion material as soon as possible.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

**Products Affected / Intel Ordering Codes:**

<b>Product Code</b>	<b>MM#</b>	<b>TA</b>
3165.NGWG	940106	H71304-006
3165.NGWG.S	940107	H72060-004

**PCN Revision History:****Date of Revision:**

December 13, 2016

**Revision Number:**

00

**Reason:**

Originally Published PCN



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**Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.**

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